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M81775FP

600V HIGH VOLTAGE THREE PHASE BRIDGE DRIVER

DESCRIPTION

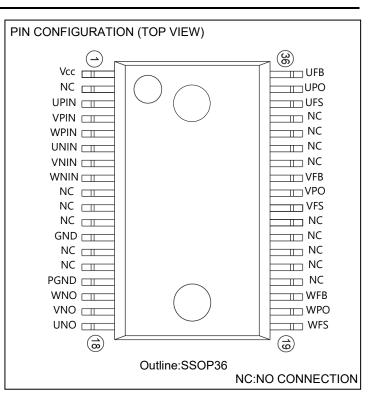
M81775FP is high voltage Power MOSFET and IGBT module driver for THREE PHASE bridge applications.

FEATURES

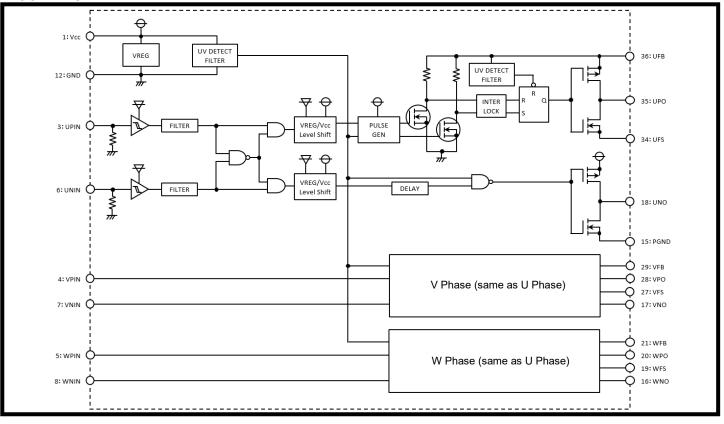
- •Floating Supply Voltage.....600V
- •Output Current+200mA/-500mA (typ)
- •3Phase Bridge Driver
- Under Voltage (UV) Lockout
- •36Pin SSOP Package

APPLICATIONS

MOSFET and IGBT module driver for refrigerator, airconditioner,washing machine, AC-servomotor, inverter and general purposes.



BLOCK DIAGRAM



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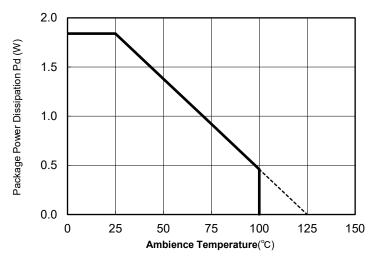
Symbol	Parameter	Conditions	Ratings	Unit
U,V,W _{FB}	High Side Floating Supply Absolute Voltage		-0.5~624	V
U,V,W _{FS}	High Side Floating Supply Offset Voltage		U,V,W _{FB} -24~U,V,W _{FS} +0.5	V
V _{BS}	High Side Floating Supply Voltage	V _{BS} =* _{FB} -* _{FS}	-0.5~24	V
U,V,W _{PO}	High Side Output Voltage		U,V,W _{FS} -0.5~U,V,W _{FB} +0.5	V
V _{cc}	Low Side Fixed Supply Voltage		-0.5~24	V
U,V,W _{NO}	Low Side Output Voltage		-0.5~V _{CC} +0.5	V
U,V,W _{IN}	Logic Input Voltage	*PIN,*NIN Terminal	-0.5~V _{CC} +0.5	V
dVS/dt	Allowable Offset Supply Voltage Transient		±50	V/ns
Pd	Package Power Dissipation	Ta=25°C,On Board	1.84	W
Kθ	Linear Derating Factor	Ta> 25°C, On Board	18.4	mW/°C
Rth(j-c)	Junction-Case Thermal Resistance		54.39	°C/W
Tj	Junction Temperature		-20~125	°C
Topr	Operation Temperature		-20~100	°C
Tstg	Storage Temperature	On Board	-40~125	°C
TL	Solder Reflow Condition	Pb-free	255:10s, max260	°C

RECOMMENDED OPERATING CONDITIONS (*: U or V or W Phase)

Symphol	Deremeter	Test conditions		L Incid			
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
U,V,W _{FB}	High Side Floating Supply Absolute Voltage		V _s +10	-	V _S +20	V	
U,V,W _{FS}	High Side Floating Supply Offset Voltage		0	-	500	V	
V _{BS}	High Side Floating Supply Voltage	V _{BS} =* _{FB} -* _{FS}	10	-	20	V	
Vcc	Low Side Fixed Supply Voltage		10		20	V	
V _{IN}	Logic Input Voltage	*PIN,*NIN Terminal	0	Ι	5	V	
V _{PGND}	Power GND		-5	_	5	V	

Note: For proper operation, the device should be used within the recommend conditions.

THERMAL DERATING FACTOR CHARACTERISTIC (MAXIMUM RATING)



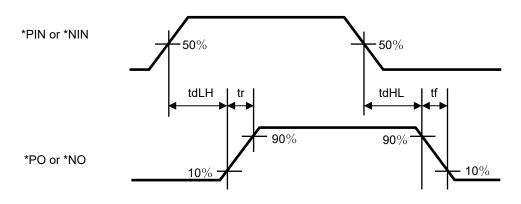
<hvid><hvid> M81775FP 600V High Voltage Three Phase Bridge Driver

ELECTRICAL CHARACTERISTICS (Ta=25°C, VCC=VBS (=VB-VS)=15V, unless otherwise specified)

Oursela al	Devenuetor	The foregoing difference	Limits			11	
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
I _{FS}	Floating Supply Leakage Current	$V_{\text{B}}\text{=}V_{\text{S}}\text{=}600V$, 1 per phase	-	-	1.0	μA	
I _{BS}	VBS Standby Current	-	0.2	0.5	mA		
I _{cc}	VCC Standby Current		-	1.0	2.0	mA	
V _{OH}	High Level Output Voltage	I ₀ =0A, *NO, *PO Terminal	14.9	-	-	V	
V _{OL}	Low Level Output Voltage	I ₀ =0A, *NO, *PO Terminal	-	-	0.1	V	
V _{IH}	High Level Input Threshold Voltage	*PIN, *NIN Terminal	2.7	-	-	V	
V _{IL}	Low Level Input Threshold Voltage	*PIN, *NIN Terminal	-	-	0.8	V	
I _{IH}	High Level Input Bias Current	*PIN, *NIN=5V	0.3	0.5	1.0	mA	
I _{IL}	Low Level Input Bias Current	*PIN, *NIN=0V	-	0	-	μA	
V _{BSuvr}	VBS Supply UV Reset Voltage		7.5	8.5	9.5	V	
V _{BSuvh}	VBS Supply UV Hysteresis Voltage		0.2	0.5	0.8	V	
tV _{BSuv}	VBS Supply UV Filter Time		-	7.5	-	μs	
V _{CCuvr}	VCC Supply UV Reset Voltage		7.5	8.5	9.5	V	
V _{CCuvh}	VCC Supply UV Hysteresis Voltage		0.2	0.5	0.8	V	
tV _{CCuv}	VCC Supply UV Filter Time		-	7.5	-	μs	
I _{он}	Output High Level Short Circuit Pulsed Current *PO,*NO=0V,*PIN,*NIN=5V, F		120	200	-	mA	
I _{OL}	Output Low Level Short Circuit Pulsed Current	*PO,*NO=15V,*PIN,*NIN=0V,PW<10µs	350	500	-	mA	
Roh	Output High Level On Resistance I ₀ =-20mA, R ₀ H=(V ₀ H-V ₀)/ I ₀		-	40	70	Ω	
R _{OL}	Output Low Level On Resistance	$I_0=20$ mA, $R_{OL}=V_0/I_0$	-	15	30	Ω	
tdLH(PO)	High Side Turn-On Propagation Delay	CL = 1000pF between *PO-* _{FS}	340	650	855	ns	
tdHL(PO)	High Side Turn-Off Propagation Delay	CL = 1000pF between *PO-* _{FS}	340	650	855	ns	
trH	High Side Turn-On Rise Time	CL = 1000pF between *PO-* _{FS}	20	130	220	ns	
tfH	High Side Turn-Off Fall Time	CL = 1000pF between *PO-* _{FS}	-	50	75	ns	
tdLH(NO)	Low Side Turn-On Propagation Delay	CL=1000pF *NO-PGND	340	650	855	ns	
tdHL(NO)			340	650	855	ns	
trL	Low Side Turn-On Rise Time	CL=1000pF *NO-PGND	20	100	200	ns	
tfL	Low Side Turn-Off Fall Time	CL=1000pF *NO-PGND	-	50	75	ns	
∆tdLH	Delay Matching, High Side and Low Side Turn-On	tdLH(PO)-tdLH(NO)	-	-	50	ns	
ΔtdHL	Delay Matching, High Side and Low Side Turn-Off	tdHL(PO)-tdHL(NO)	-	-	50	ns	
		*PIN, *NIN : Convex Pulse	260	380	500	ns	
tfilter	Input Filter Time	*PIN, *NIN : Concave Pulse	310	450	590	ns	

Note: Typ is not specified

INPUT/OUTPUT TIMING DIAGRAM



<нvic> M81775FP

600V HIGH VOLTAGE THREE PHASE BRIDGE DRIVER

FUNCTION TABLE (*: U or V or W Phase)

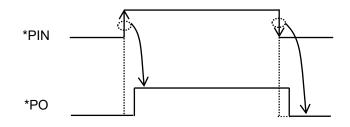
U,V,WPIN	U,V,WNIN	UV(VCC)	UV(VBS)	U,V,WPO	U,V,WNO	Behavioral state	
H→L	L	н	Н	L	L	*PO = L, *NO = L	
H→L	Н	Н	Н	L	Н	*NO = H	
L→H	L	Н	Н	Н	L	*PO ON = H	
L→H	Н	х	Н	L	L	*NO,*PO = L when *PIN, *NIN is "L" at the same time	
x	L	Н	L	L	L	*PO = L when VBS UV tripped.	
H→L	х	L	н	L	L	L *NO = L when VCC UV tripped	

Note1 : "L" state of VBS UV, VCC UV means that UV trip voltage.

Note2 : In the case of both input signals (*PIN and *NIN) are "H", output signals (*PO and *NO) become "L".

Note3 : X (*PIN) : L \rightarrow H or H \rightarrow LO X (*HIN) : H or L.

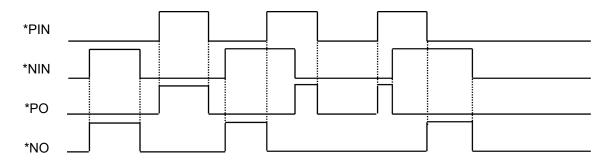
Note4 : Output Signal (*PO) is triggered by the edge of input signal.



TIMING DIAGRAM

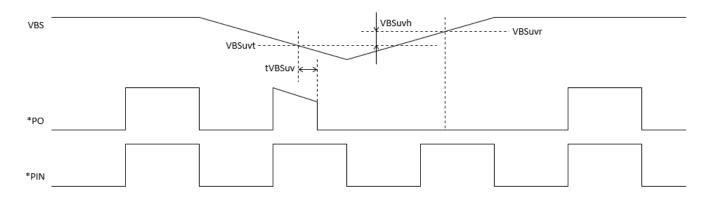
1. INPUT/OUTPUT TIMING DIAGRAM

High Active, in the case of both input signals (*PIN, *NIN) are "H", output signals (*PO, *NO) become "L".

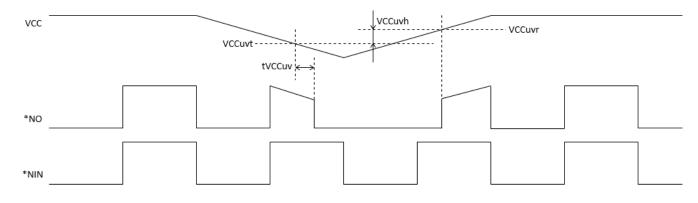


2. VCC (VBS) Supply Under Voltage Lockout Timing Diagram

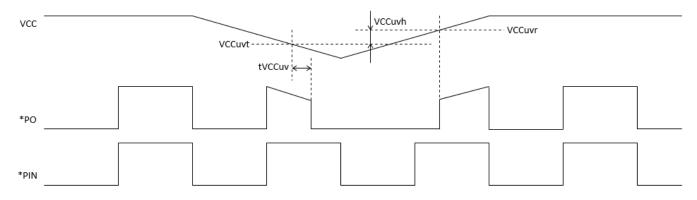
If VBS supply voltage drops below UV trip voltage (VBSuvt) for VBS supply UV filter time, output signal is shut down. As soon as VBS supply voltage rises over UV reset voltage, output signal *PO becomes "H" at following edge of input signal.



If VCC supply voltage drops below UV trip voltage (VCCuvt) for VCC supply UV filter time, *NO output signal is shut down. As soon as VCC supply voltage rises over UV reset voltage, output signal *NO becomes "H" if *NIN input signal is "H".



If VCC supply voltage drops below UV trip voltage (VCCuvt) for VCC supply UV filter time, *PO output signal is shut down. As soon as VCC supply voltage rises over UV reset voltage, output signal *PO becomes "H" if *PIN input signal is "H".



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3. Allowable Supply Voltage Transient(* : U or V or W Phase)

(1) Allowable supply voltage transient

It is recommended to supply VCC firstly and supply VBS secondly. In the case of shutting off supply voltage, please shut off VBS firstly and shut off VCC secondly.

When applying VCC and VBS, power supply should be applied slowly. If it rises rapidly, output signal (HO* or LO*) may be malfunction.

(2) Supply voltage start up or restart after shut down

If VCC supply is less than 10V(outside of RECOMMENDED OPERATING CONDITIONS), there is some possibility that output does not change in response to input.

Please evaluate carefully about supply start up or restart after shut down in your application systems.

(3) VB* supply voltage

Please use VB* supply voltage within RECOMMENDED OPERATING CONDITIONS(VS* +10V < VB*). If VB* supply voltage is used on the other conditions, output signal HO* may be malfunction. Please evaluate carefully about VB* supply voltage in your application systems.

(4) Processing between IC terminals

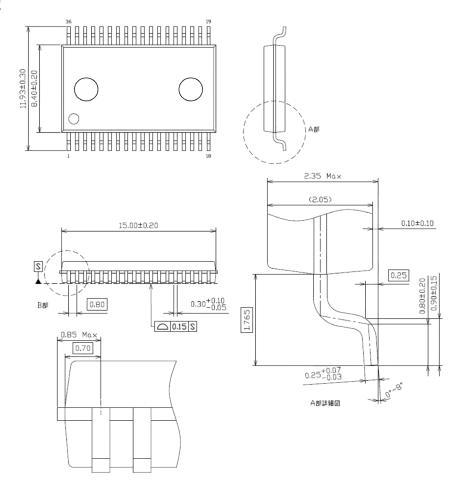
As for this product, the terminal of low voltage part and high voltage part are arranged across the NC terminal (The 14th:LOU, The 16th: VSW). In addition, terminals between 3phase of high voltage parts are adjacent. (The 18th: VBW, The 19th:VSV) (The 21th: VBV, The 22th: VSU).

Therefore, if insulation space distance of those terminals can not be enough, please coat between those terminals.

ENVIRONMENTAL CONSCIOUSNESS

M81775FP is compliant with the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) directive 2011/65/EU+(EU)2015/863.

PACKAGE OUTLINE



<hr/> <hr/> <hr/> <hr/> M81775FP </hr> 600V HIGH VOLTAGE THREE PHASE BRIDGE DRIVER

Main Revision for this Edition

Revision			Revision				
Rev.	Date	Pages Points					
A	15 Jun. 2017	- rages	New				
	10 00						
В	8 May. 2018	-	"PRELIMINARY" was deleted				
		P2	"()" was deleted in Ratings of Pd, Kθ,Rth(j-c)				
С	28 Apr. 2021	-	Update format				

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